



Proximity Sensor for Guided Unitary Multiple Launch Rocket System

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Electronics Development Corporation

Overview

- System Background
- System Requirements
- Design Challenges
- Design
 - Antenna/Radome
 - ◆ Electronics
 - Signal Processor
 - Transceiver







System Background

Multiple-Launch Rocket System (MLRS)

- Legacy system
 - ☞ LRIP 1980

Ballistic trajectory

DPICM payload

- ◆ GPS/IMU Guidance added 2000
- ◆DPICM payload with unitary 2002
 - Seeded proximity sensor for maximum lethality
 - ☞ KDI/EDC turned on in December 2003







System Requirements

- Selectable Height of Burst (HOB) : 3m/10m
- 15° to 110° approach angle
 - Roll-stabilized
- 250m/s to 850m/s approach velocity
- Built-in-Test (BIT)







Design Challenges

- Radome/Antenna
 - ◆ Thermal environment
 - Solution Nose gets EXTREMELY hot
 - Cover push-through
 - Tube exit presents significant mechanical load
 - ◆ Broad angle of attack







Design Challenges

Electronics

◆ Velocity

Exceeds capabilities of existing transceiver/processor chip sets

♦ BIT

The Not available with legacy ASIC-based signal processors

- Aggressive Schedule
 - Approximately 13 months to CDR







Radome/Antenna

- Proposed concept was simple patch antenna and plastic radome (PEEK)
 - Antenna would be tilted to provide shallow angle coverage
 - ◆ PEEK has been used in rocket applications



Radome/Antenna

- LM concerned about thermal and mechanical radome environments
 - ♦ High temperature due to velocity
 - Severe tube-exit mechanical stress
- After contract award, LM analysis shows that PEEK won't with stand environments
 - Suggest that nose must be metal....!







Radome/Antenna Concepts

- A window on the side of a metal nose would be provided for the antenna
- Various concepts were considered
 - ◆ Waveguide aperture
 - ◆ Patch antenna mounted in/under window
- Analysis tool was needed
 - ◆ KDI acquired a 3D EM analysis tool to quickly evaluate various options







Waveguide Aperture

- Window would form waveguide aperture
 - Provided good coverage
 - Not practical to build/assemble









Waveguide Aperture









Patch Under Window

Simple patch antenna mounted under window

- Difficult to mount
- Less-than-optimal pattern









Patch Under Window









Ceramic Radome To The Rescue!

- Concurrently with KDI/EDC, LM did extensive thermal and mechanical analysis of nose tip
 - Identified proprietary ceramic material that could serve as entire radome/nose tip

The Will withstand thermal and push-through environments

Greatly simplified mounting concerns
Back to original concept







Not So Fast...

- High dielectric constant had significant influence on pattern (and impedance)
 - Original 20 degree tilt concept didn't work too well



Un-tilted Antenna



Un-tilted Antenna

Horizontal cut

◆ Antenna rotated so that this corresponds to pitch plane





Final Antenna Configuration

Show figure of 3D pattern



Final Antenna Configuration









Antenna Performance

Pitch Plane, Measured vs Calculated



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Electronics Design Signal Processor

- Requirements precluded use of existing signal processor
 - ◆ High velocities result in Doppler frequencies outside the passband of existing mortar and artillery processing systems
 - ◆ Built-in-Test (BIT) not possible with existing processors
 - ◆ Aggressive schedule made new ASIC impossible







Electronics Design Signal Processor

- KDI/EDC leveraged previous IRAD work to design completely new signal processing system
 - ◆ All parameters are re-configurable
 - ◆ Reports BIT status to ESAF, which reports to Mission Computer
 - ◆ All components are commercially available **Procession No custom IC's!**







Electronics Design Transceiver

- Antenna/Radome design yielded good results, but only at a frequency significantly different than those used on legacy mortar and artillery systems
 - Could not use existing transceivers
 - ◆ Aggressive schedule made new MMIC impossible
 - New transceiver designed with commercially available components
 - **~** No custom IC's!







Electronics Assembly









Summary

- Difficult radome/antenna problem solved through TEAMWORK
 - Concurrent electromagnetic, thermal, and mechanical analysis
- Electronics contains NO custom components
 - Rapid development
 - ♦ Versatile design
- First shot success (see next slide)!













